

40V N-Channel Enhancement Mode MOSFET

Description

The AP100N04NF uses advanced APM-SGT II technology

to provide excellent $R_{\text{DS}(\text{ON})},$ low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a Battery protection

or in other Switching application.

General Features

V_{DS} = 40V I_D =100A

 $R_{DS(ON)} < 3.2m\Omega @ V_{GS}=10V$ (Type: 2.1m Ω)

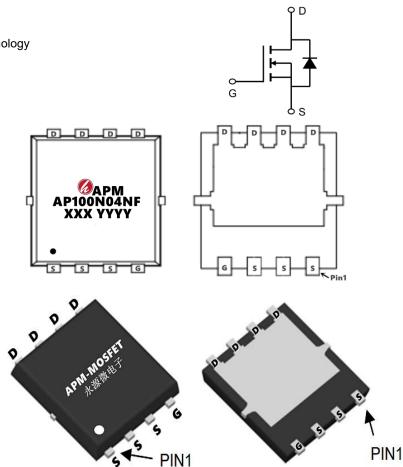
Ciss≈2600PF

Application

Boost driver

Brushless motor

BLDC



Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS) 5000	
AP100N04NF	DFN5*6-8L	AP100N04NF XXX YYYY		
bsolute Maximu	n Ratings (T _c =25℃unless otherwise n	oted)		
Symbol	Parameter	Rating	Units	
VDS	Drain-Source Voltage	40	V	
VGS	Gate-Source Voltage	±20	V	
ID@TC=25°C	Continuous Drain Current, VGS @ 10V1	100	А	
ID@TC=100°C	Continuous Drain Current, VGS @ 10V1	71	A	
IDM	Pulsed Drain Current2	240	А	
EAS	Single Pulse Avalanche Energy3	345	mJ	
IAS	Avalanche Current	54	А	
PD@TC=25℃	Total Power Dissipation4	22	W	
TSTG	Storage Temperature Range	-55 to 150	°C	
TJ	Operating Junction Temperature Range	-55 to 150	°C	
RθJA	Thermal Resistance Junction-Ambient 1 25		°C/W	
RθJC	Thermal Resistance Junction-Case1	1.7	°C/W	



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Electrical Characteristics (TJ=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	40	44		V	
RDS(ON)	Static Drain-Source On-Resistance ²	V_{GS} =10V , I _D =20A		2.1	3.2		
		V _{GS} =4.5V , I _D =15A		2.7	5.3	mΩ	
VGS(th)	Gate Threshold Voltage	V_{GS} = V_{DS} , I_D =250uA	1.2	1.7	2.5	V	
IDSS	Drain-Source Leakage Current	V _{DS} =40V , V _{GS} =0V , T _J =25°C			1 uA		
IDSS	Drain-Source Leakage Current	V _{DS} =40V , V _{GS} =0V , T _J =55°C			5	- uA	
IGSS	Gate-Source Leakage Current	V_{GS} =±20V , V_{DS} =0V			±100	nA	
gfs	Forward Transconductance	V _{DS} =5V , I _D =20A		75		S	
Rg	Gate Resistance	V _{DS} =0V , V _{GS} =0V , f=1MHz		1.5		Ω	
Qg	Total Gate Charge (4.5V)			22.7		nC	
Qgs	Gate-Source Charge	V _{DS} =20V , V _{GS} =4.5V , I _D =20A		7.5			
Qgd	Gate-Drain Charge			5.5			
Td(on)	Turn-On Delay Time			10			
Tr	Rise Time	V _{DD} =20V , V _{GS} =10V ,		5			
Td(off)	Turn-Off Delay Time	$R_G=3\Omega$, $I_D=20A$		33		ns	
T _f	Fall Time			6.5			
Ciss	Input Capacitance			2600			
Coss	Output Capacitance	V _{DS} =20V , V _{GS} =0V , f=1MHz		899		pF	
Crss	Reverse Transfer Capacitance			71			
IS	Continuous Source Current ^{1,5}	$V_G=V_D=0V$, Force Current			30	А	
VSD	Diode Forward Voltage ²	V _{GS} =0V , Is=1A , Tյ=25℃			1	V	

Note :

1. The data tested by surface mounted on a 1 inch 2 FR-4 board with 2OZ copper.

2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3、The EAS data shows Max. rating . The test condition is VDD =32V,VGS =10V,L=0.1mH,IAS =54A

4. The power dissipation is limited by 150° C junction temperature

5. The data is theoretically the same as I D and I DM, in real applications, should be limited by total power dissipation.

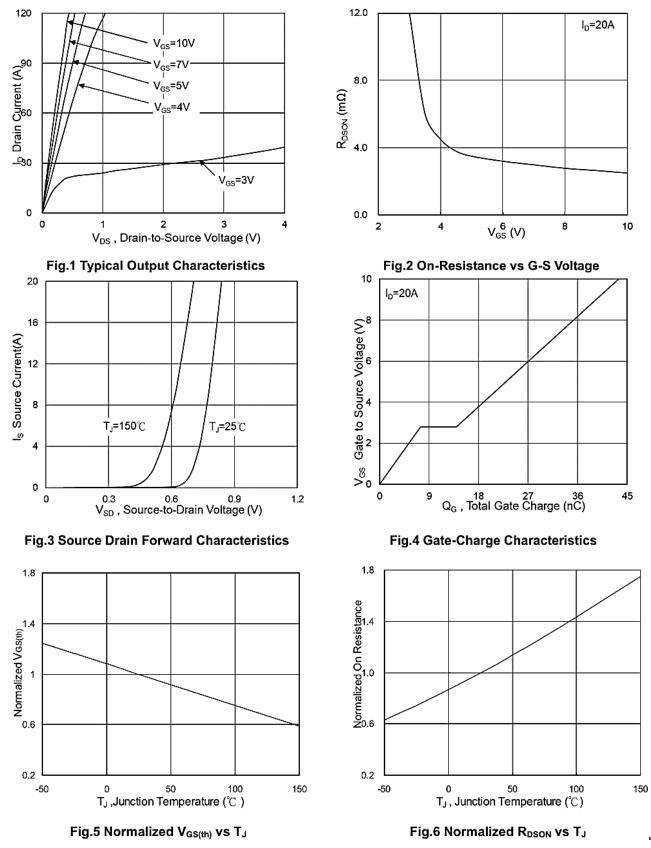
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<u>AP100N04NF</u>

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Typical Characteristics





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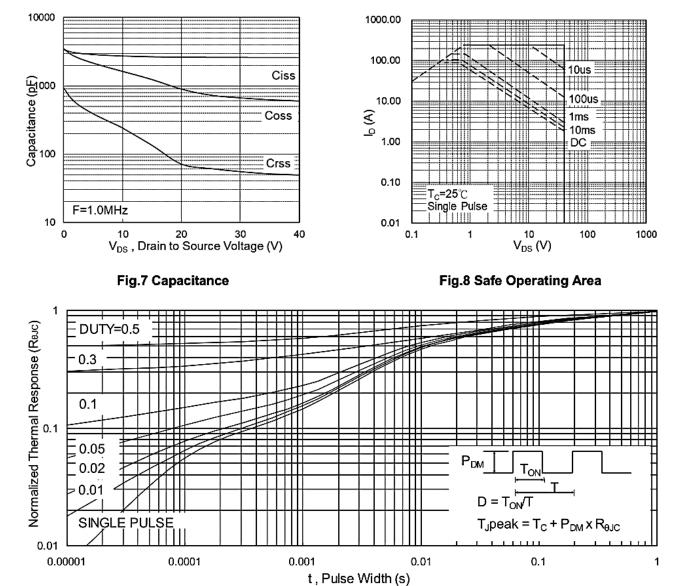


Fig.9 Normalized Maximum Transient Thermal Impedance

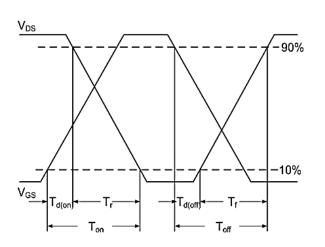


Fig.10 Switching Time Waveform

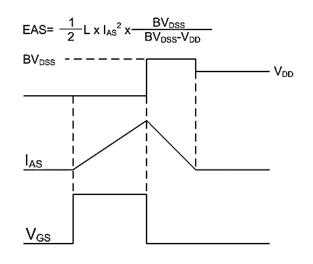
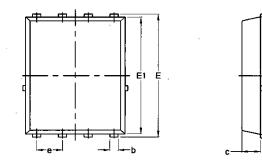


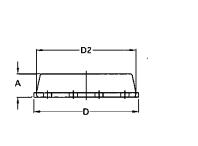
Fig.11 Unclamped Inductive Switching Wave

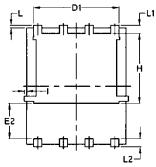


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Package Mechanical Data-PDFN5*6-8L-JQ Single







		Com	mon		
Symbol	mm		Inch		
	Mim	Max	Min	Max	
A	1.03	1.17	0.0406	0.0461	
b	0.34	0.48	0.0134	0.0189	
С	0.824	0.0970	0.0324	0.082	
D	4.80	5.40	0.1890	0.2126	
D1	4.11	4.31	0.1618	0.1697	
D2	4.80	5.00	0.1890	0.1969	
E	5.95	6.15	0.2343	0.2421	
E1	5.65	5.85	0.2224	0.2303	
E2	1.60	/	0.0630	/	
e	1.27	BSC	0.05	BSC	
L	0.05	0.25	0.0020	0.0098	
L1	0.38	0.50	0.0150	0.0197	
L2	0.38	0.50	0.0150	0.0197	
Н	3.30	3.50	0.1299	0.1378	
Ι	/	0.18	/	0.0070	



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Edition	Date	Change
Rev1.0	2021/9/31	Initial release
Rev1.1	2021/4/20	Reduce(RDS)

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